

< High Voltage Insulated Gate Bipolar Transistor : HVIGBT >

# CM1200DA-34X

HIGH POWER SWITCHING USE  
INSULATED TYPE

6th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

## CM1200DA-34X



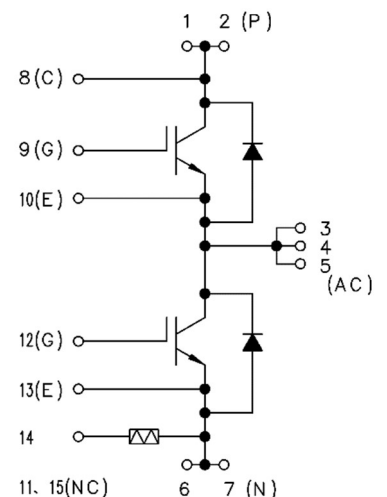
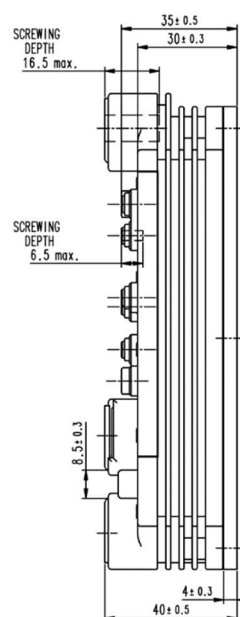
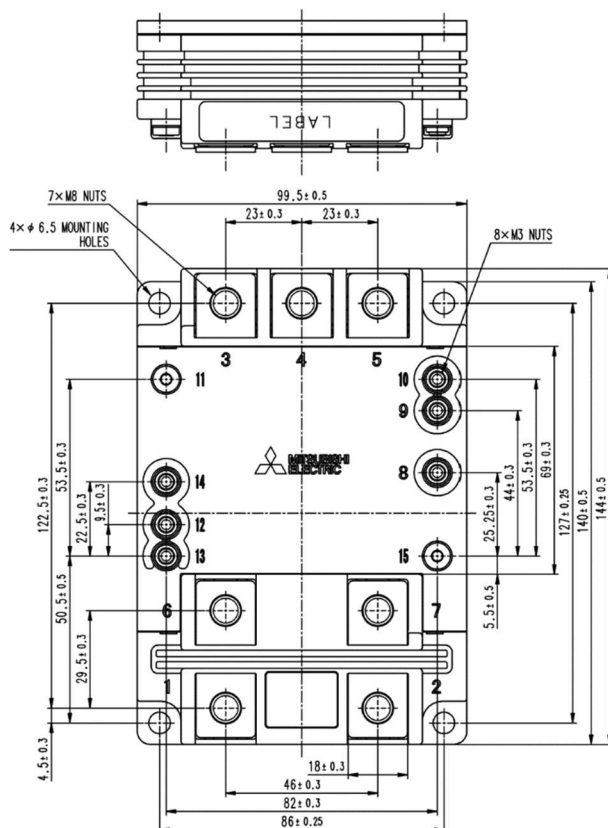
- $I_C$ ..... 1200A
- $V_{CES}$ ..... 1700V
- 2-elements in a Pack
- Insulated Type (Al base type)
- CSTBT™(III) / RFC Diode

## APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers

### OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



接線図  
CIRCUIT DIAGRAM

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**MAXIMUM RATINGS**

Symbol	Item	Conditions	Ratings	Unit
$V_{CES}$	Collector-emitter voltage	$V_{GE} = 0V, T_J = 25 \dots +150^{\circ}C$	1700	V
		$V_{GE} = 0V, T_J = -50^{\circ}C$	1550	
$V_{GES}$	Gate-emitter voltage	$V_{CE} = 0V, T_J = 25^{\circ}C$	$\pm 20$	V
$I_C$	Collector current	DC, $T_C = 98^{\circ}C$	1200	A
$I_{CRM}$		Pulse (Note 1)	2400	A
$I_E$	Emitter current (Note 2)	DC, $T_C = 70^{\circ}C$	1200	A
$I_{ERM}$		Pulse (Note 1)	2400	A
$P_{tot}$	Maximum power dissipation (Note 3)	$T_C = 25^{\circ}C$ , IGBT part	7500	W
$V_{iso}$	Isolation voltage	RMS, sinusoidal, $f = 60Hz$ , $t = 1 \text{ min.}$ , $T_C = 25^{\circ}C$	6000	V
$Q_{PD}$	Partial discharge	Charged part to the baseplate $V_1 = 3500 \text{ Vrms}$ , $V_2 = 2600 \text{ Vrms}$ AC 60 Hz, $T_C = 25^{\circ}C$ (acc. to IEC 61287)	10	pC
$T_J$	Junction temperature		$-50 \sim +150$	$^{\circ}C$
$T_{Jop}$	Operating junction temperature		$-50 \sim +150$	$^{\circ}C$
$T_{stg}$	Storage temperature		$-55 \sim +150$	$^{\circ}C$
$t_{psc}$	Short circuit pulse width	$V_{CC} = 1200V$ , $V_{CE} \leq V_{CES}$ , $V_{GE} = 15V$ , $T_J = 150^{\circ}C$ $R_{G(on)} = 1.1\Omega$ , $R_{G(off)} = 6.8\Omega$ , $C_{GE} = 33nF$	6.5	$\mu s$

**ELECTRICAL CHARACTERISTICS**

Symbol	Item	Conditions		Limits			Unit
				Min	Typ	Max	
I <sub>CES</sub>	Collector cutoff current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0V	T <sub>J</sub> = 25°C	—	—	4.0	mA
			T <sub>J</sub> = 125°C	—	1.5	—	
			T <sub>J</sub> = 150°C	—	9.0	—	
V <sub>GE(th)</sub>	Gate-emitter threshold voltage	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 120 mA, T <sub>J</sub> = 25°C		5.5	6.0	6.5	V
I <sub>GES</sub>	Gate leakage current	V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0V, T <sub>J</sub> = 25°C		−0.5	—	0.5	μA
C <sub>ies</sub>	Input capacitance	V <sub>CE</sub> = 10 V, V <sub>GE</sub> = 0 V, f = 100 kHz T <sub>J</sub> = 25°C		—	330	—	nF
C <sub>oes</sub>	Output capacitance			—	7.2	—	nF
C <sub>res</sub>	Reverse transfer capacitance			—	2.9	—	nF
Q <sub>G</sub>	Total gate charge	V <sub>CC</sub> = 900V, I <sub>C</sub> = 1200A, V <sub>GE</sub> = ±15V		—	20.5	—	μC
V <sub>CEsat</sub>	Collector-emitter saturation voltage	I <sub>C</sub> = 1200 A (Note 4) V <sub>GE</sub> = 15 V	T <sub>J</sub> = 25°C	—	1.80	—	V
			T <sub>J</sub> = 125°C	—	2.15	—	
			T <sub>J</sub> = 150°C	—	2.20	2.60	
t <sub>d(on)</sub>	Turn-on delay time	V <sub>CC</sub> = 900 V I <sub>C</sub> = 1200 A V <sub>GE</sub> = ±15 V R <sub>G(on)</sub> = 1.1 Ω L <sub>s</sub> = 40nH	T <sub>J</sub> = 150°C	—	—	1.30	μs
t <sub>r</sub>	Rise time		T <sub>J</sub> = 150°C	—	—	0.50	μs
E <sub>on(10%)</sub>	Turn-on switching energy per pulse (Note 5)		T <sub>J</sub> = 25°C	—	0.27	—	J
		T <sub>J</sub> = 125°C	—	0.38	—		
		T <sub>J</sub> = 150°C	—	0.40	—		
E <sub>on</sub>	Turn-on switching energy per pulse (Note 6)	Inductive load C <sub>GE</sub> = 33nF	T <sub>J</sub> = 25°C	—	0.30	—	J
			T <sub>J</sub> = 125°C	—	0.40	—	
			T <sub>J</sub> = 150°C	—	0.43	—	
t <sub>d(off)</sub>	Turn-off delay time	V <sub>CC</sub> = 900 V I <sub>C</sub> = 1200 A V <sub>GE</sub> = ±15 V R <sub>G(off)</sub> = 6.8Ω L <sub>s</sub> = 40nH Inductive load C <sub>GE</sub> = 33nF	T <sub>J</sub> = 25°C	—	3.10	—	μs
			T <sub>J</sub> = 125°C	—	3.20	—	
			T <sub>J</sub> = 150°C	—	3.25	5.00	
t <sub>f</sub>	Fall time		T <sub>J</sub> = 25°C	—	0.16	—	μs
			T <sub>J</sub> = 125°C	—	0.19	—	
			T <sub>J</sub> = 150°C	—	0.20	0.50	
E <sub>off(10%)</sub>	Turn-off switching energy per pulse (Note 5)		T <sub>J</sub> = 25°C	—	0.30	—	J
			T <sub>J</sub> = 125°C	—	0.36	—	
			T <sub>J</sub> = 150°C	—	0.39	—	
E <sub>off</sub>	Turn-off switching energy per pulse (Note 6)		T <sub>J</sub> = 25°C	—	0.36	—	J
		T <sub>J</sub> = 125°C	—	0.48	—		
		T <sub>J</sub> = 150°C	—	0.49	—		

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**ELECTRICAL CHARACTERISTICS (continuation)**

Symbol	Item	Conditions		Limits			Unit
				Min	Typ	Max	
V <sub>EC</sub>	Emitter-collector voltage (Note 2)	I <sub>E</sub> = 1200 A (Note 4) V <sub>GE</sub> = 0 V	T <sub>J</sub> = 25°C	—	1.80	—	V
			T <sub>J</sub> = 125°C	—	1.90	—	
			T <sub>J</sub> = 150°C	—	1.90	2.40	
t <sub>rr</sub>	Reverse recovery time (Note 2)	V <sub>CC</sub> = 900 V I <sub>C</sub> = 1200 A V <sub>GE</sub> = ±15 V R <sub>G(on)</sub> = 1.1Ω L <sub>s</sub> = 40nH Inductive load C <sub>GE</sub> = 33nF	T <sub>J</sub> = 25°C	—	0.35	—	μs
			T <sub>J</sub> = 125°C	—	0.50	—	
			T <sub>J</sub> = 150°C	—	0.53	—	
I <sub>rr</sub>	Reverse recovery current (Note 2)		T <sub>J</sub> = 25°C	—	830	—	A
			T <sub>J</sub> = 125°C	—	860	—	
			T <sub>J</sub> = 150°C	—	880	—	
Q <sub>rr(10%)</sub>	Reverse recovery charge (Note 2) (Note 7)		T <sub>J</sub> = 25°C	—	195	—	μC
			T <sub>J</sub> = 125°C	—	310	—	
			T <sub>J</sub> = 150°C	—	335	—	
Q <sub>rr</sub>	Reverse recovery charge (Note 2) (Note 6)		T <sub>J</sub> = 25°C	—	205	—	μC
			T <sub>J</sub> = 125°C	—	320	—	
			T <sub>J</sub> = 150°C	—	350	—	
E <sub>rec(10%)</sub>	Reverse recovery energy per pulse (Note 2) (Note 5)		T <sub>J</sub> = 25°C	—	0.13	—	J
			T <sub>J</sub> = 125°C	—	0.17	—	
			T <sub>J</sub> = 150°C	—	0.18	—	
E <sub>rec</sub>	Reverse recovery energy per pulse (Note 2) (Note 6)		T <sub>J</sub> = 25°C	—	0.13	—	J
			T <sub>J</sub> = 125°C	—	0.21	—	
			T <sub>J</sub> = 150°C	—	0.22	—	

**THERMAL CHARACTERISTICS**

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
$R_{th(j-c)Q}$	Thermal resistance	Junction to Case, IGBT part, 1/2 module	—	—	16.5	K/kW
$R_{th(j-c)D}$		Junction to Case, FWDi part, per 1/2 module	—	—	27.0	K/kW
$R_{th(c-s)}$	Contact thermal resistance	Case to heat sink, 1/2 module $\lambda_{grease} = 1\text{ W/m}\cdot\text{K}$ , $D_{(c-s)} = 70\mu\text{m}$	—	16.0	—	K/kW

**NTC THERMISTOR PART**

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
$R_{25}$	Zero-power resistance	$T_e = 25^\circ\text{C}$	-	5.00	-	k $\Omega$
$B_{(25/50)}$	B-constant (Note 8)	Approximate by equation	-	3375	-	K

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**MECHANICAL CHARACTERISTICS**

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
M <sub>t</sub>	Mounting torque	Main terminals screw M8	7.0	—	14.0	N·m
M <sub>s</sub>		Mounting screw M6	3.0	—	6.0	N·m
M <sub>i</sub>		Auxiliary terminals screw M3	0.4	—	1.0	N·m
m	Mass		—	0.75	—	kg
CTI	Comparative tracking index		600	—	—	—
d <sub>a</sub>	Clearance	Between terminals and baseplate	19.5	—	—	mm
d <sub>s</sub>	Creepage distance	Between terminals and baseplate	32.0	—	—	mm
L <sub>P-P-N</sub>	Parasitic stray inductance	Between terminal 1, 2 and terminal 6, 7	—	10.0	—	nH
R <sub>CC+EE</sub>	Internal lead resistance	T <sub>C</sub> = 25 °C, 1/2 module	—	0.41	—	mΩ

Note 1. Pulse width and repetition rate should be such that junction temperature (T<sub>j</sub>) does not exceed T<sub>jopmax</sub> rating.

Note 2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWD<sub>i</sub>).

Note 3. Junction temperature (T<sub>j</sub>) should not exceed T<sub>jmax</sub> rating (150°C).

Note 4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

Note 5. The integration range of switching energies is from 10%V<sub>CE</sub> to 10%I<sub>C</sub>(10%I<sub>E</sub>).

Note 6. Definition of all items is according to IEC 60747, unless otherwise specified.

Note 7. The integration range of reverse recovery charge is from I<sub>E</sub> = 0A to 10%I<sub>E</sub>.

Note 8.  $B_{(25/50)} = \ln \left( \frac{R_{25}}{R_{50}} \right) / \left( \frac{1}{T_{25}} - \frac{1}{T_{50}} \right)$

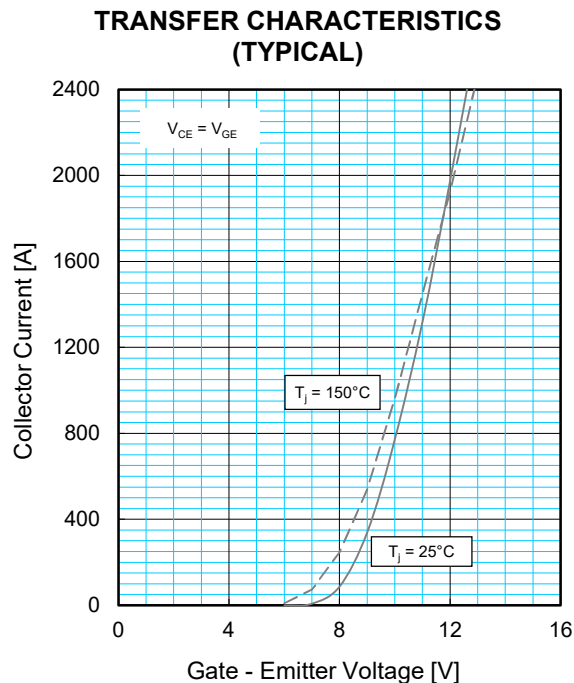
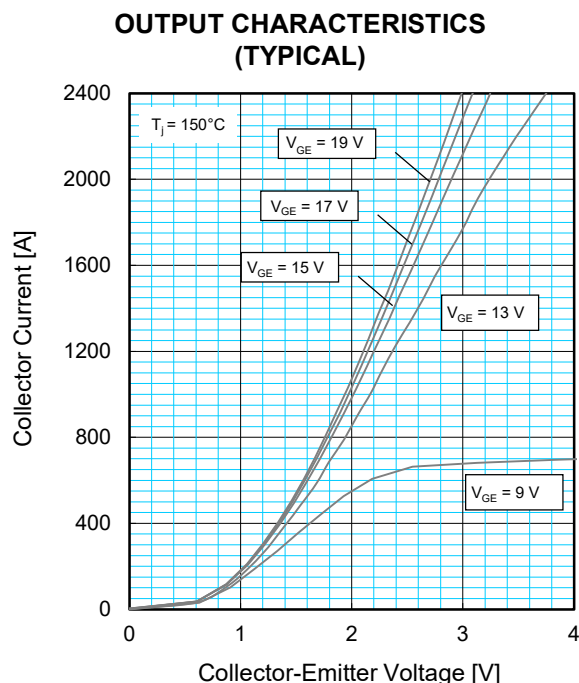
R<sub>25</sub>: resistance at 25°C

R<sub>50</sub>: resistance at 50°C

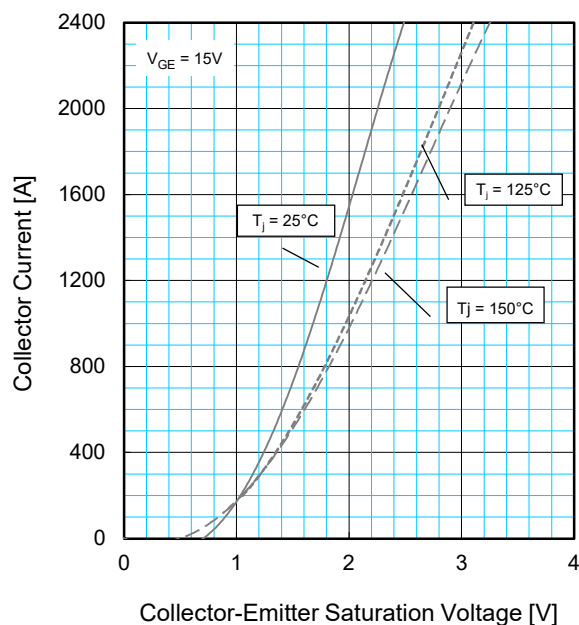
T<sub>25</sub> [K]; T<sub>25</sub> = 25[°C] + 273.15 = 298.15[K]

T<sub>50</sub> [K]; T<sub>50</sub> = 50[°C] + 273.15 = 323.15[K]

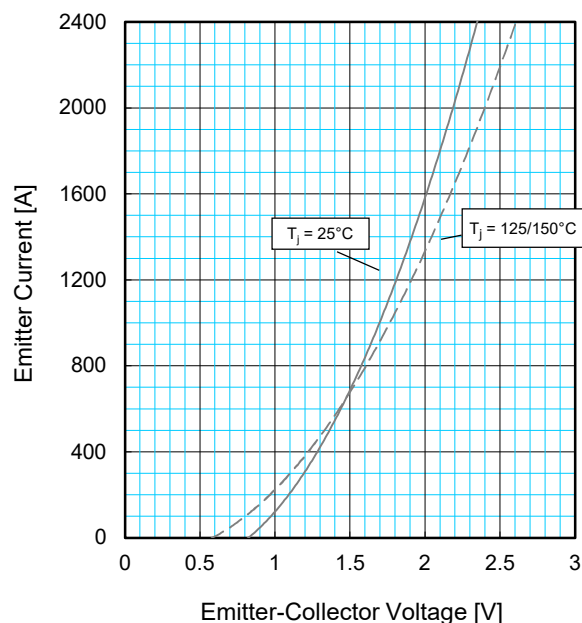
**PERFORMANCE CURVES**



**COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)**

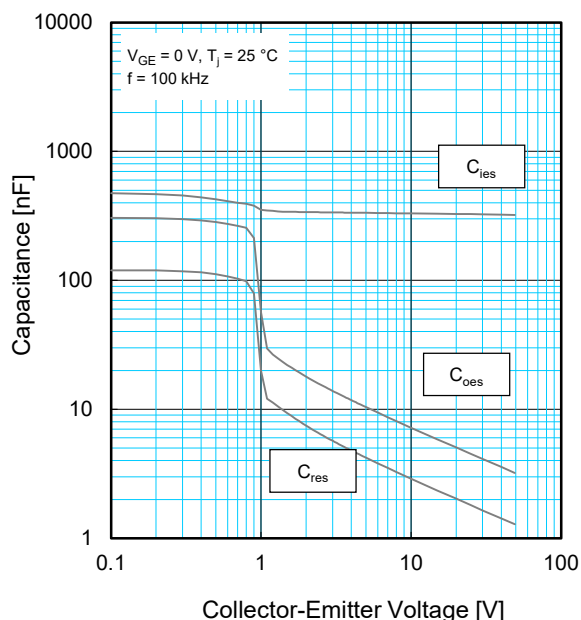


**FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)**

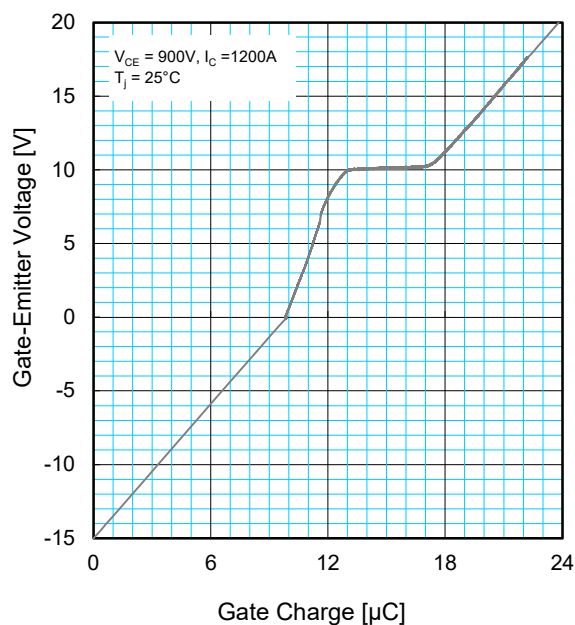


**PERFORMANCE CURVES**

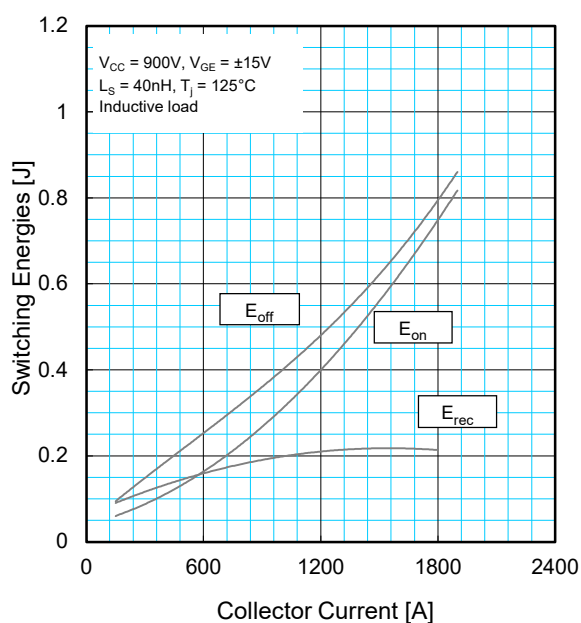
**CAPACITANCE CHARACTERISTICS  
(TYPICAL)**



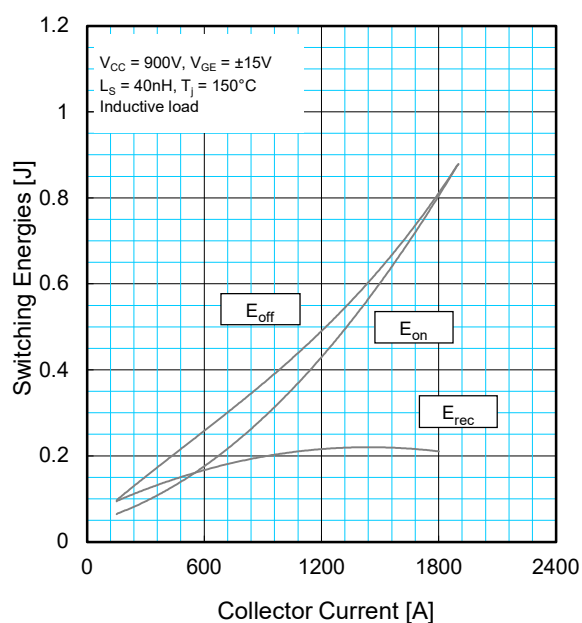
**GATE CHARGE CHARACTERISTICS  
(TYPICAL)**

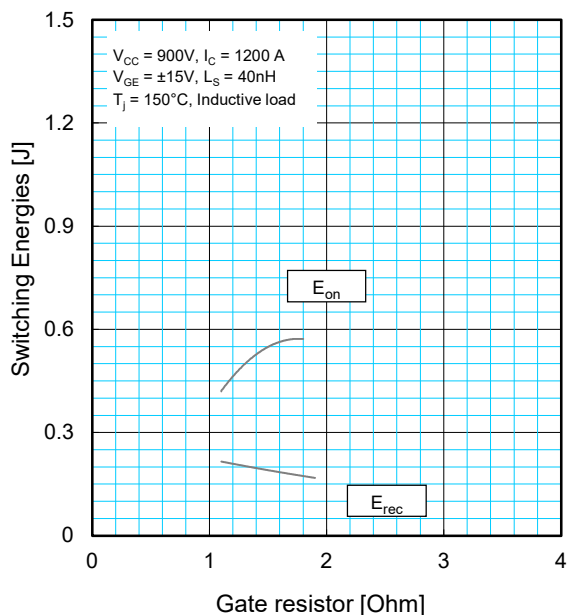
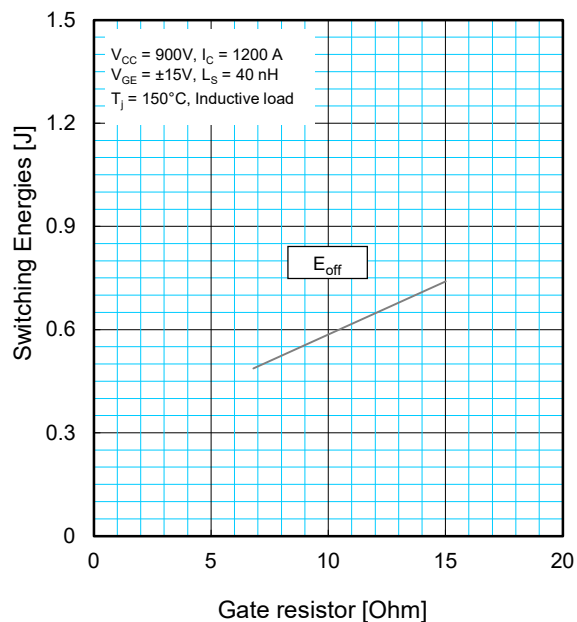
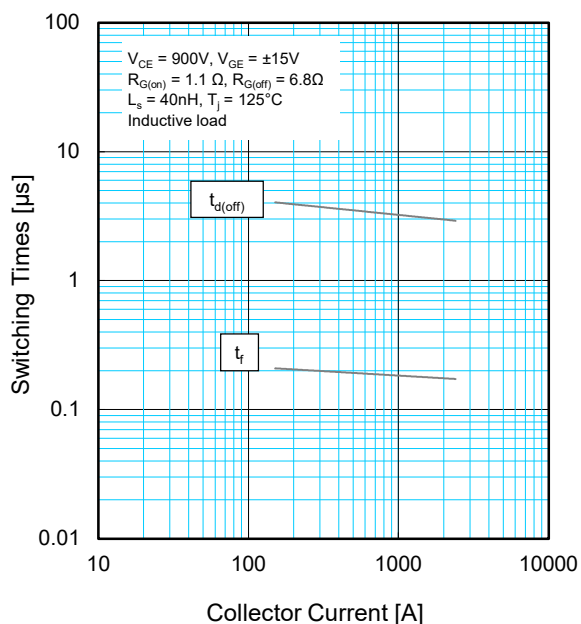
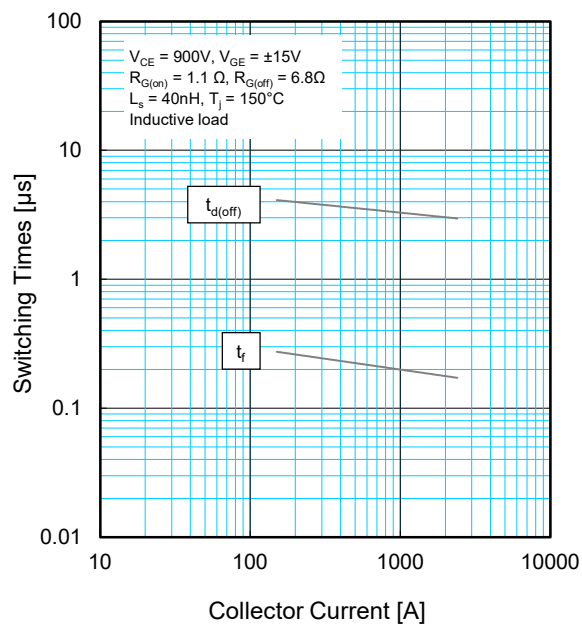


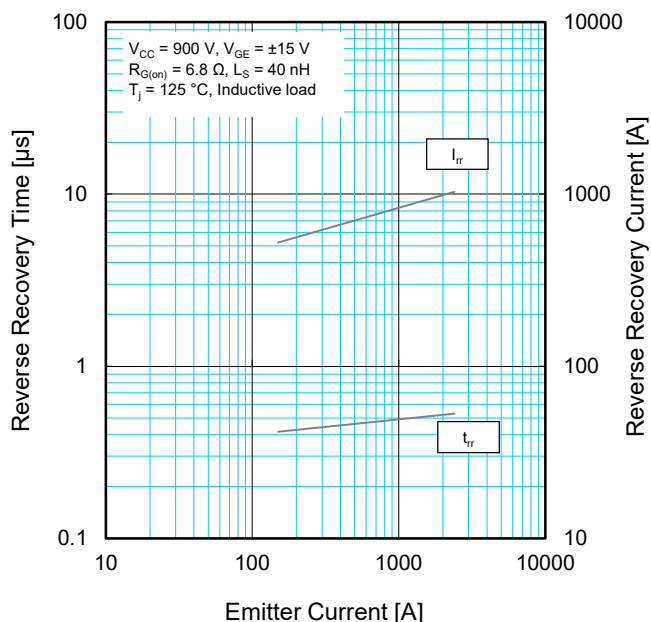
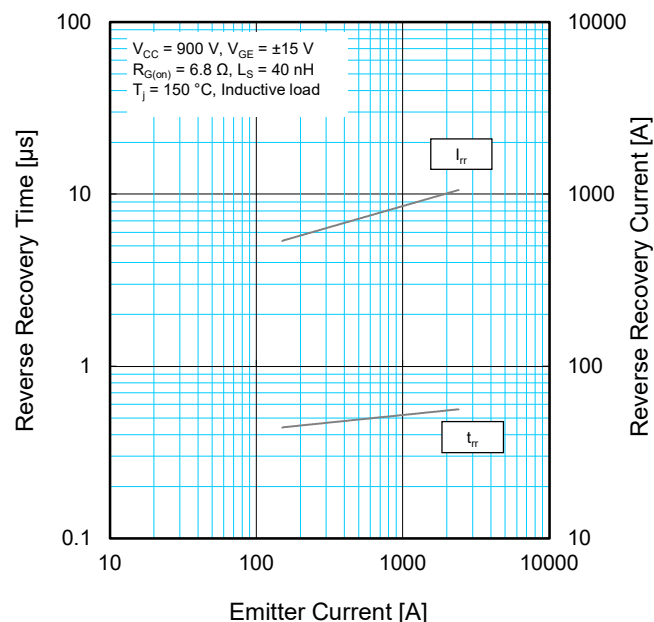
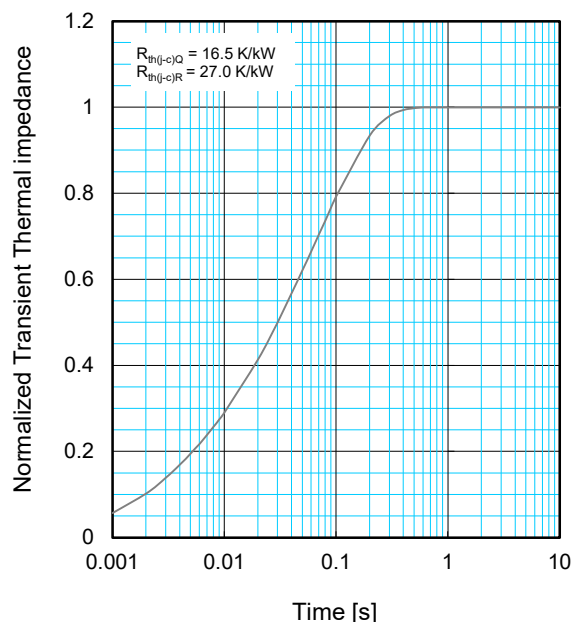
**HALF-BRIDGE SWITCHING ENERGY  
CHARACTERISTICS (TYPICAL)**



**HALF-BRIDGE SWITCHING ENERGY  
CHARACTERISTICS (TYPICAL)**



**PERFORMANCE CURVES****HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)****HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)****HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)****HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)**

**PERFORMANCE CURVES****FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)****FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)****TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS**

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i \left\{ 1 - \exp\left(-\frac{t}{\tau_i}\right) \right\}$$

	1	2	3	4
$R_i / R_{th(j-c)} :$	0.0292	0.0832	0.2277	0.6599
$\tau_i [\text{sec.}] :$	0.0025	0.0027	0.0155	0.0865



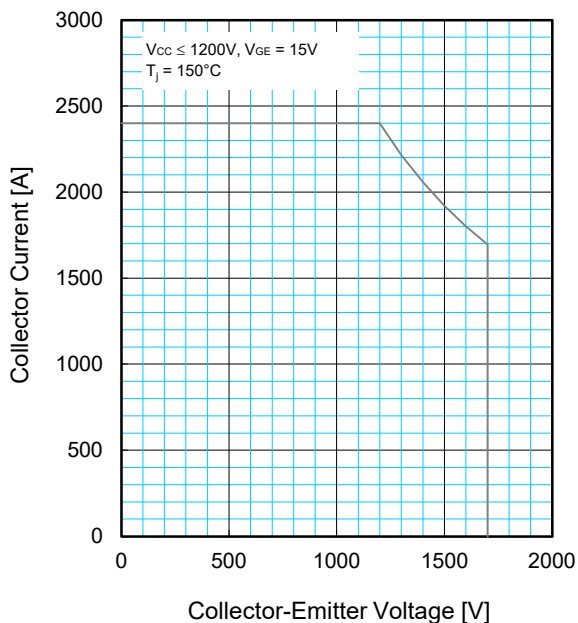
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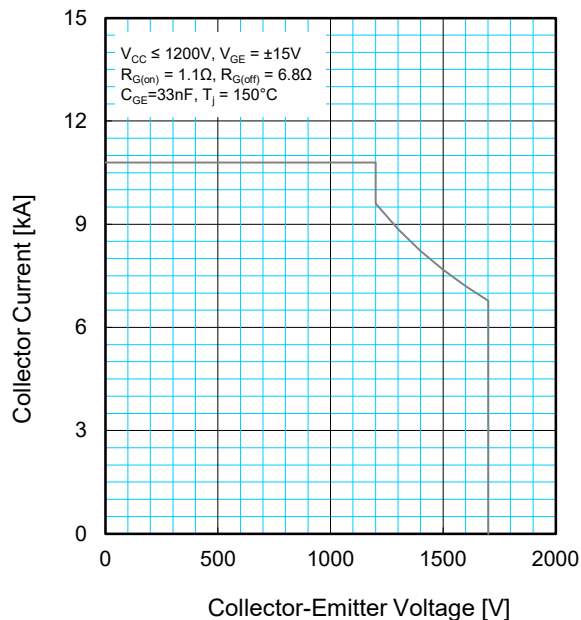
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### PERFORMANCE CURVES

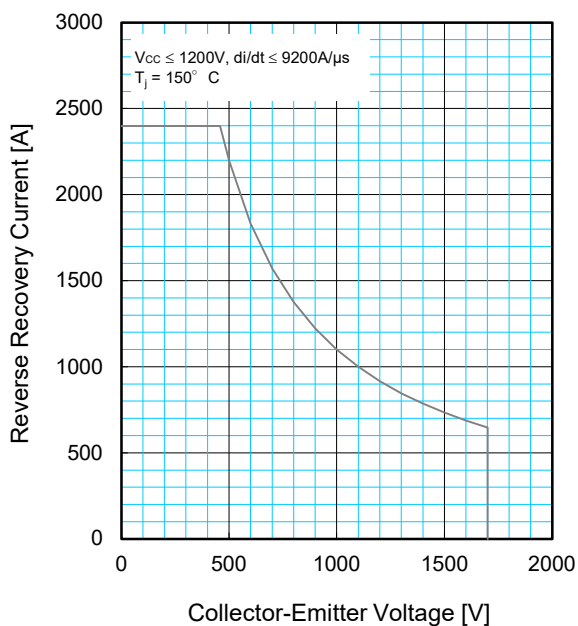
**REVERSE BIAS SAFE OPERATING AREA (RBSOA)**



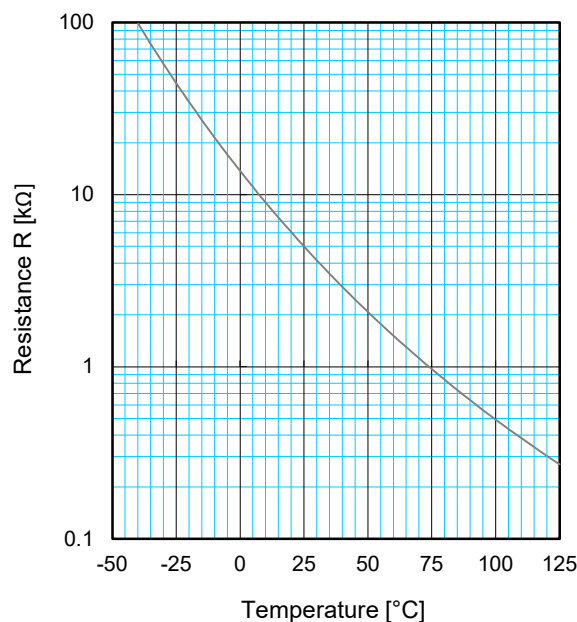
**SHORT CIRCUIT SAFE OPERATING AREA (SCSOA)**



**FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)**



**NTC THERMISTOR TEMPERATURE CHARACTERISTICS (TYPICAL)**



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